

DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

High Frequency Automotive Grade

NP0 16 V TO 50 V

0.1 pF to 100 pF RoHS compliant & Halogen Free



YAGEO

Product Specification – February 8, 2021 V.1





Surface-Mount Ceramic Multilayer Capacitors

High Frequency Automotive grade

16 V to 50 V

NP0

<u>SCOPE</u>

This specification describes Automotive grade NPO series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- · AEC-Q200 qualified
- MSL class: MSL I
- AQ series soldering is compliant with J-STD-020D
- · Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

GLOBAL PART NUMBER

AQ <u>xxxx</u> <u>x</u> <u>x</u> <u>xxx</u> <u>xxx</u> <u>x</u> **B** <u>x</u> <u>xxxx</u> (6) (7)

(I) SIZE - INCH BASED (METRIC)

0603 (1608)

(2) TOLERANCE

0.1pF

 $B = \pm 0.1 pF$

0.2pF to 2.0pF

 $A = \pm 0.05 pF$

 $B = \pm 0.1 pF$

 $C = \pm 0.25 pF$

2.1 pF to 5.0 pF

 $A = \pm 0.05 pF$

 $B = \pm 0.1 pF$

 $C = \pm 0.25 \text{ pF}$

 $D = \pm 0.5 pF$

5.1 pF to 9.9 pF

 $B = \pm 0.1 \text{ pF}$

 $C = \pm 0.25 \text{ pF}$

 $D = \pm 0.5 pF$

10pF and over

 $F = \pm 1\%$

 $G = \pm 2\%$

 $| = \pm 5\%$

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

(5) RATED VOLTAGE

7 = 16 V

8 = 25 V

9 = 50 V

(6) PROCESS

N = NP0

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

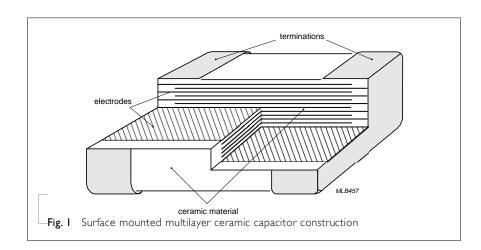
NP0

CONSTRUCTION

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The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig.I.

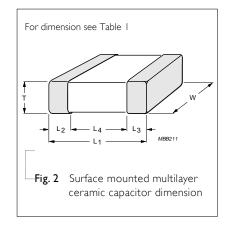


DIMENSION

Table I For outlines see fig. 2

TYPE	L _I (mm)	W (mm)	T (MM)	L ₂ / min.	L ₃ (mm) max.	L ₄ (mm) min.
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.40
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40

OUTLINES





NP0

16 V to 50 V

CAPACITANCE RANGE & THICKNESS FOR NPO

Table 2 Sizes 0402 to 0603

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CAP.	0402	0603	CAP.	0402	0603
CAF.	50V	50 V	CAF.	50 V	50 V
0.1 pF	0.5±0.05		2.6 pF	0.5±0.05	0.8±0.1
0.2 pF	0.5±0.05	0.8±0.1	2.7 pF	0.5±0.05	0.8±0.1
0.3 pF	0.5±0.05	0.8±0.1	2.8 pF	0.5±0.05	0.8±0.1
0.4 pF	0.5±0.05	0.8±0.1	2.9 pF	0.5±0.05	0.8±0.1
0.5 pF	0.5±0.05	0.8±0.1	3.0 pF	0.5±0.05	0.8±0.1
0.6 pF	0.5±0.05	0.8±0.1	3.1 pF	0.5±0.05	0.8±0.1
0.7 pF	0.5±0.05	0.8±0.1	3.2 pF	0.5±0.05	0.8±0.1
0.8 pF	0.5±0.05	0.8±0.1	3.3 pF	0.5±0.05	0.8±0.1
0.9 pF	0.5±0.05	0.8±0.1	3.4 pF	0.5±0.05	0.8±0.1
1.0 pF	0.5±0.05	0.8±0.1	3.5 pF	0.5±0.05	0.8±0.1
I.I pF	0.5±0.05	0.8±0.1	3.6 pF	0.5±0.05	0.8±0.1
I.2 pF	0.5±0.05	0.8±0.1	3.7 pF	0.5±0.05	0.8±0.1
1.3 pF	0.5±0.05	0.8±0.1	3.8 pF	0.5±0.05	0.8±0.1
I.4 pF	0.5±0.05	0.8±0.1	3.9 pF	0.5±0.05	0.8±0.1
1.5 pF	0.5±0.05	0.8±0.1	4.0 pF	0.5±0.05	0.8±0.1
I.6 pF	0.5±0.05	0.8±0.1	4.1 pF	0.5±0.05	0.8±0.1
1.7 pF	0.5±0.05	0.8±0.1	4.2 pF	0.5±0.05	0.8±0.1
1.8 pF	0.5±0.05	0.8±0.1	4.3 pF	0.5±0.05	0.8±0.1
1.9 pF	0.5±0.05	0.8±0.1	4.4 pF	0.5±0.05	0.8±0.1
2.0 pF	0.5±0.05	0.8±0.1	4.5 pF	0.5±0.05	0.8±0.1
2.1 pF	0.5±0.05	0.8±0.1	4.6 pF	0.5±0.05	0.8±0.1
2.2 pF	0.5±0.05	0.8±0.1	4.7 pF	0.5±0.05	0.8±0.1
2.3 pF	0.5±0.05	0.8±0.1	4.8 pF	0.5±0.05	0.8±0.1
2.4 pF	0.5±0.05	0.8±0.1	4.9 pF	0.5±0.05	0.8±0.1
2.5 pF	0.5±0.05	0.8±0.1	5.0 pF	0.5±0.05	0.8±0.1

NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-I2 series is on request



NP0 16 V to 50 V

CAPACITANCE RANGE & THICKNESS FOR NPO

Table 3 Sizes 0402 to 0603

CAP.	0402	0603	CAP.	0402	0603
C/ ti .	50V	50 V	C/ ti .	50 V	50 V
5.1 pF	0.5±0.05	0.8±0.1	8.2 pF	0.5±0.05	0.8±0.1
5.2 pF	0.5±0.05	0.8±0.1	8.3 pF	0.5±0.05	0.8±0.1
5.3 pF	0.5±0.05	0.8±0.1	8.4 pF	0.5±0.05	0.8±0.1
5.4 pF	0.5±0.05	0.8±0.1	8.5 pF	0.5±0.05	0.8±0.1
5.5 pF	0.5±0.05	0.8±0.1	8.6 pF	0.5±0.05	0.8±0.1
5.6 pF	0.5±0.05	0.8±0.1	8.7 pF	0.5±0.05	0.8±0.1
5.7 pF	0.5±0.05	0.8±0.1	8.8 pF	0.5±0.05	0.8±0.1
5.8 pF	0.5±0.05	0.8±0.1	8.9 pF	0.5±0.05	0.8±0.1
5.9 pF	0.5±0.05	0.8±0.1	9.0 pF	0.5±0.05	0.8±0.1
6.0 pF	0.5±0.05	0.8±0.1	9.1 pF	0.5±0.05	0.8±0.1
6.1 pF	0.5±0.05	0.8±0.1	9.2 pF	0.5±0.05	0.8±0.1
6.2 pF	0.5±0.05	0.8±0.1	9.3 pF	0.5±0.05	0.8±0.1
6.3 pF	0.5±0.05	0.8±0.1	9.4 pF	0.5±0.05	0.8±0.1
6.4 pF	0.5±0.05	0.8±0.1	9.5 pF	0.5±0.05	0.8±0.1
6.5 pF	0.5±0.05	0.8±0.1	9.6 pF	0.5±0.05	0.8±0.1
6.6 pF	0.5±0.05	0.8±0.1	9.7 pF	0.5±0.05	0.8±0.1
6.7 pF	0.5±0.05	0.8±0.1	9.8 pF	0.5±0.05	0.8±0.1
6.8 pF	0.5±0.05	0.8±0.1	9.9 pF	0.5±0.05	0.8±0.1
6.9 pF	0.5±0.05	0.8±0.1	I0 pF	0.5±0.05	0.8±0.1
7.0 pF	0.5±0.05	0.8±0.1	I2 pF	0.5±0.05	0.8±0.1
7.1 pF	0.5±0.05	0.8±0.1	15 pF	0.5±0.05	0.8±0.1
7.2 pF	0.5±0.05	0.8±0.1	18 pF	0.5±0.05	0.8±0.1
7.3 pF	0.5±0.05	0.8±0.1	22 pF	0.5±0.05	0.8±0.1
7.4 pF	0.5±0.05	0.8±0.1	27 pF	0.5±0.05	0.8±0.1
7.5 pF	0.5±0.05	0.8±0.1	33 pF	0.5±0.05	0.8±0.1
7.6 pF	0.5±0.05	0.8±0.1	39 pF	0.5±0.05	0.8±0.1
7.7 pF	0.5±0.05	0.8±0.1	47 pF	0.5±0.05	0.8±0.1
7.8 pF	0.5±0.05	0.8±0.1	56 pF	0.5±0.05	0.8±0.1
7.9 pF	0.5±0.05	0.8±0.1	68 pF	0.5±0.05	0.8±0.1
8.0 pF	0.5±0.05	0.8±0.1	82 pF	0.5±0.05	0.8±0.1
8.1 pF	0.5±0.05	0.8±0.1	100 pF	0.5±0.05	0.8±0.1

NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-12 series is on request



High Frequency Automotive grade

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THICKNESS CLASSES AND PACKING QUANTITY

Table 4

SIZE	THICKNESS	TAPE WIDTH -	Ø180	MM / 7 INCH	Ø330	MM / 13 INCH
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister
0402	0.5 ±0.05 mm	8 mm	10,000		50,000	
0603	0.8 ±0.1 mm	8 mm	4,000		15,000	

ELECTRICAL CHARACTERISTICS

NP0 DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

Temperature: 15 °C to 35 °C
Relative humidity: 25% to 75%
Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

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DESCRIPTION				
Capacit	ance range	0.1 pF to 100 pF		
Capacit	ance tolerance			
NP0	C < 10 pF	±0.05 pF, ±0.1 pF, ±0.25 pF, ±0.5 pF		
	C ≥ 10 pF	±1%, ±2%, ±5%		
Dissipat	tion factor (D.F.)			
NP0	C < 30 pF	≤ I / (400 + 20C)		
	C ≥ 30 pF	≤ 0.1 %		
Insulation	on resistance after 1 minute at U _r (DC)	IR≥ 10 GΩ		
	um capacitance change as a function of temperature rature characteristic/coefficient):			
NP0		±30 ppm/°C		
Operat	ing temperature range:	-		
NP0		-55 °C to +125 °C		





High Frequency Automotive grade **Surface-Mount Ceramic Multilayer Capacitors** 16 V to 50 V NP0

SOLDERING RECOMMENDATION

Table 6					
SOLDERING	SIZE				
METHOD	0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

TESTS AND REQUIREMENTS

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

Table 7 Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage	
Capacitance	IEC 60384- 21/22	4.5.1	Class I: At 20 °C, 24 hours after annealing $f = I$ MHz for $C \le I$ nF, measuring at voltage I V _{rms} at 20 °C $f = I$ KHz for $C > I$ nF, measuring at voltage I V _{rms} at 20 °C	Within specified tolerance	
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20 °C, 24 hours after annealing $f = 1$ MHz for $C \le InF$, measuring at voltage I V_{rms} at 20 °C $f = 1$ KHz for $C > InF$, measuring at voltage I V_{rms} at 20 °C	In accordance with specification	
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U _r (DC) for I minute	In accordance with specification	



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TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Temperature coefficient	TEST FIET	4.6	Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage. Step Temperature(°C) a 25±2 b Lower temperature±3°C c 25±2 d Upper Temperature±2°C e 25±2 (I) Class I Temperature Coefficient shall be calculated from the formula as below Temp, Coefficient = $\frac{C2 - CI}{CI \times \Delta T} \times 10^6$ [ppm/°C] C1: Capacitance at step c C2: Capacitance at 125°C ΔT : 100 °C(=125°C-25°C) (2) Class II Capacitance Change shall be calculated from the formula as below $\Delta C = \frac{C2 - CI}{CI} \times 100\%$ C1: Capacitance at step c C2: Capacitance at step c	<pre><general purpose="" series=""> Class I: Δ C/C: ±30ppm</general></pre>
High Temperature Exposure	AEC-Q200	3	Unpowered; 1000hours @ T=150°C Measurement at 24±2 hours after test conclusion.	No visual damage Δ C/C : Class I: NP0: within ±0.5% or 0.5 pF whichever is greater
Temperature Cycling	AEC-Q200	4	Preconditioning: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours	No visual damage \[\Delta C/C \] Class I: NP0: Within \(\pm 1\%\) or 0.5pF, whichever is greater. D.F. meet initial specified value IR meet initial specified value
Destructive Physical Analysis	AEC-Q200	5	Note: Only applies to SMD ceramics. Electrical test not required.	

NP0

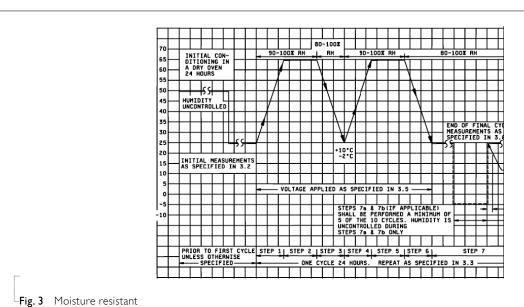
IR

NP0: \geq 10,000 M Ω



Surface-Mount Ceramic Multilayer Capacitors

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Moisture Resistance	AEC-Q200 6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage
		reasonation at 21 22 hours are test contained.	$\Delta \text{C/C}$ NP0: Within $\pm 3\%$ or 3 pF, whichever is greater
			D.F.
			Within initial specified value



Biased Humidity AEC-Q200

- 1. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp
- 2. Initial measure:

Parameter: IR

Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 K Ω

3. Test condition:

85 °C, 85% R.H. connected with 100 K $\!\Omega$ resistor, applied 1.5V/U_r for 1,000 hours.

4. Recovery:

Class I: 6 to 24 hours Class2: 24 ±2 hours

5. Final measure: IR

No visual damage after recovery

Initial requirement:

Class I:

- Connected to 100 K Ω : $C \le 10 \text{ nF: I.R} \ge 10,000 \text{ M}\Omega \text{ or}$

C > 10 nF: (I.R-100 K Ω) x C ≥ 100s.

Final measurement:

The insulation resistance shall be greater than 0.1 time initial value.





Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

16 V to 50 V

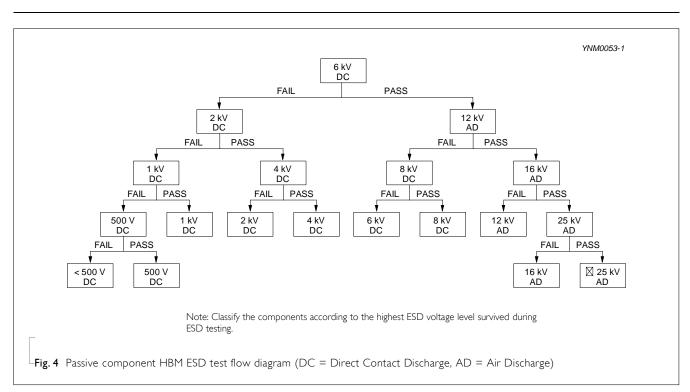
TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Operational Life	AEC-Q200	8	 I. Initial measure: Spec: refer to initial spec C, D, IR Endurance test: Specified stress voltage applied for I,000 hours: Applied 2.0 x U_r for general products Recovery time: 24 ±2 hours Final measure: C, D, IR Note: If the capacitance value is less than the minimum 	No visual damage $\Delta C/C$ NP0: Within $\pm 2\%$ or 1 pF, whichever is greater $D.F.$ NP0: $\leq 2 \times \text{specified value}.$ IR $NP0: \geq 4,000 \text{ M}\Omega \text{ or } \text{IR} \times C_r \geq 40 \text{s}$	
External Visual	AEC-Q200	9	value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met. Any applicable method using × 10 magnification	whichever is less In accordance with specification	
	,	·	7 Wy applicable method doing 10 mag illeation	in accordance with specification	
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification	
Mechanical Shock	AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms	$\Delta C/C$ NP0: Within $\pm 0.5\%$ or 0.5 pF, whichever is greater	
			Velocity change: 15.4 ft/s Waveform: Half-sin	D.F. Within initial specified value IR Within initial specified value	
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" x 5" PCB. 0.31" thick 7 secure points on one long side and 2 secure points at corners of opposite	Δ C/C NP0: Within ±0.5% or 0.5 pF, whichever is greater	
			sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.	D.F: meet initial specified value IR meet initial specified value	
Resistance to Soldering Heat	AEC-Q200	15	Precondition: $150 + 0/-10$ °C for I hour, then keep for 24 ± 1 hours at room temperature Preheating: for size ≤ 1206 : 120 °C to 150 °C for I	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned	
			minute Preheating: for size > 1206: 100 °C to 120 °C for I minute and 170 °C to 200 °C for I minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds	ΔC/C Class I: NP0: Within ±1% or 0.5 pF, whichever is greater.	
			Recovery time: 24 ±2 hours	D.F. within initial specified value IR within initial specified value	



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16 V to 50 V NP0

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS
Thermal Shock	AEC-Q200	16	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at .	No visual damage
			room temp 2. Initial measure:	$\Delta C/C$ NP0: Within $\pm 1\%$ or 1 pF, whichever
			Spec: refer to initial spec C, D, IR 3. Rapid change of temperature test:	is greater
			NP0: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature. 4. Recovery time:	D.F: meet initial specified value IR meet initial specified value
			Class 1: 6 to 24 hours Class 2: 24 ±2 hours 5. Final measure: C, D, IR	
ESD	AEC-Q200	17	Per AEC-Q200-002	A component passes a voltage level if all components stressed at that voltage level pass.



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TEST

Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

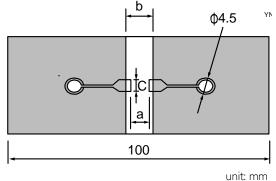
PROCEDURE

TEST METHOD

NP0 16 V to 50 V

REQUIREMENTS

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Solderability	AEC-Q200	18	Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination.	
			Test conditions for lead containing solder alloy Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: 1 Test conditions for lead-free containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305		
			Number of immersions: I		
Electrical Characterization	AEC-Q200 19		Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures.	ΔC/C Class I: NP0: ±30 ppm/°C	
			Class I: NP0: -55 °C to +125 °C Normal temperature: 20 °C		
Board Flex	AEC-Q200	21	Part mounted on a 100 mm \times 40 mm FR4 PCB board, which is 1.6 \pm 0.2 mm thick and has a layer-thickness 35 μ m \pm 10 μ m. Part should be mounted using the following soldering reflow profile. Conditions: Class I: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm	No visible damage $\Delta C/C$ Class I: NP0: Within $\pm 1\%$ or 0.5 pF, whichever is greater	
			Test Substrate:	Dimension(mm)	
			, b ,	Time a la	



	Dimension(mm)		
Туре	а	b	С
0201	0.3	0.9	0.3
0402	0.4	1.5	0.5
0603	1.0	3.0	1.2
0805	1.2	4.0	1.65
1206	2.2	5.0	1.65
1210	2.2	5.0	2.0
1808	3.5	7.0	3.7

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TEST	TEST METHOD		PROCEDURE	REQUIREMENTS
Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before, during and after the test, the device shall comply with all electrical requirements stated in this specification.
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	\leq 0805 Thickness > 0.5mm: 20N Thickness \leq 0.5mm: 8N \geq 1206 Thickness \geq 1.25 mm: 54N Thickness \leq 1.25 mm: 15N
Voltage Proof			1. Specified stress voltage applied for $1 \sim 5$ seconds 2. Ur ≤ 100 V: series applied 2.5 Ur 3. 100 V $<$ Ur ≤ 200 V series applied (1.5 Ur + 100) 4. 200 V $<$ Ur ≤ 500 V series applied (1.3 Ur + 100) 5. Ur > 500 V: 1.3 Ur 6. Ur ≥ 1000 V: 1.2 Ur Charge/Discharge current is less than 50 mA	No breakdown or flashover
ESR			Measuring frequency: I \pm 0.2GHz at room temperature.	$0.1 \text{pF} \le C \le 1 \text{pF} : 350 \text{m}\Omega \text{ / C max}$ $1 \text{pF} < C \le 5 \text{pF} : 300 \text{m}\Omega \text{ max}$ $5 \text{pF} < C \le 10 \text{pF} : 250 \text{m}\Omega \text{ max}$ $C : \text{Nominal cap (pF)}$
			Measuring frequency: $500 \pm 50 \text{MHz}$ at room temperature.	10pF < C ≤ 100pF :400mΩ max



Product specification $\frac{14}{15}$ Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade NP0 16 V to 50 V

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version I	Feb. 08, 2021	-	- Add 0402 / 0.1 pf~ 100pF
Version 0	Dec. 14, 2018	-	- New



Surface-Mount Ceramic Multilayer Capacitors

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